



安徽蓝讯通信技术有限公司

Anhui Lan-Xun Communication Technology Co., Ltd

## Datasheet of Ceramic Component

Product : Chip Antenna

Frequency : 2400-2500 MHz

P/N : LX.ANT-3216-2450-001

\*Contents in this sheet are subject to change without prior notice.

## Antenna Size : 3216

### 1. Features

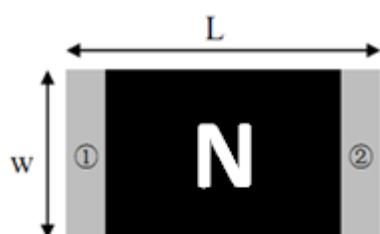
Antenna Frequency for 2400-2500 MHz

### 2. Applications

For Miniaturized Bluetooth System

### 3. Shapes & Dimensions(mm)

#### 1). Component :



Number	Terminal Name
①	INPUT
②	NC

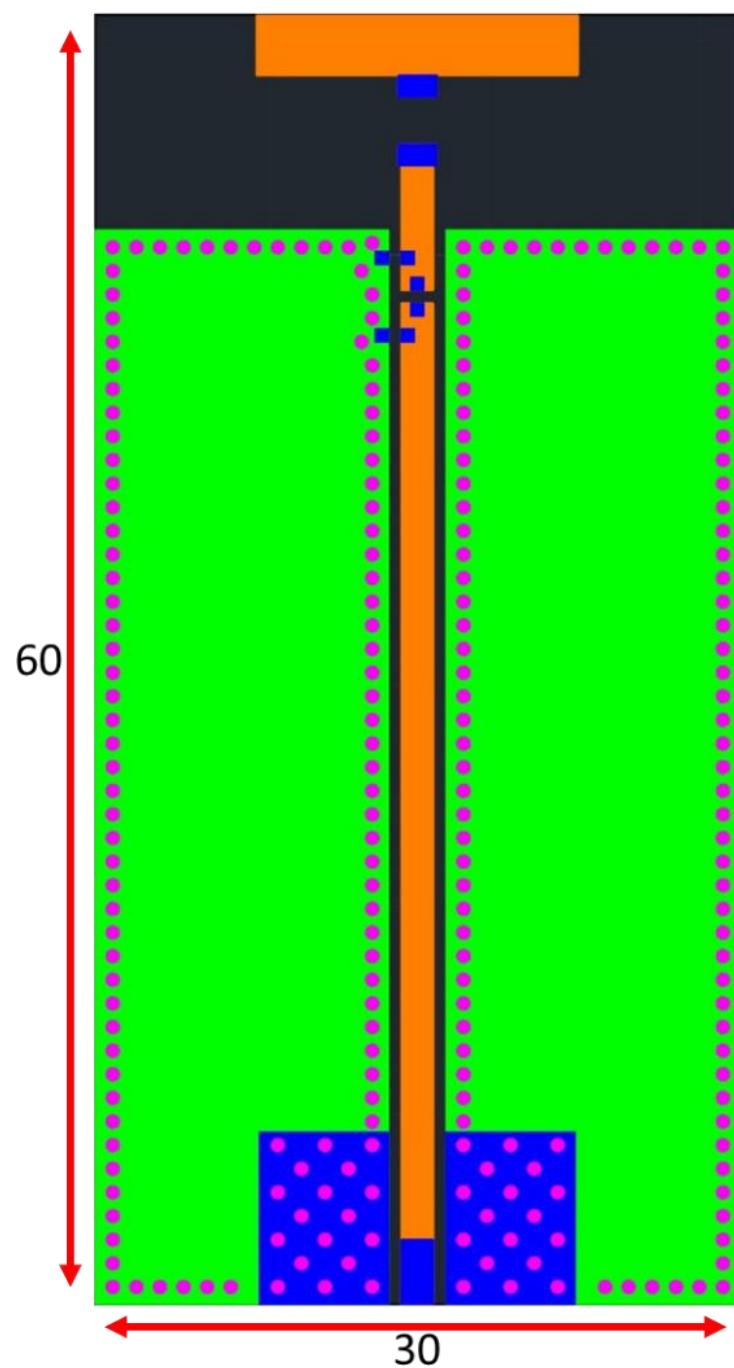
( Top View )

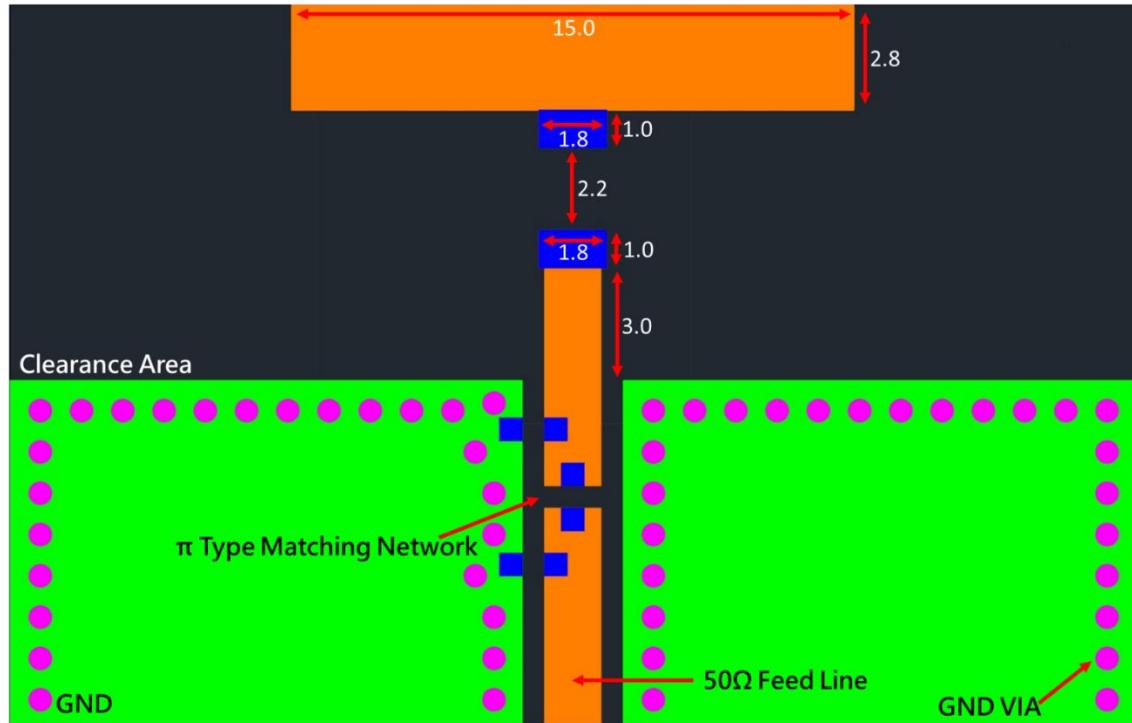


( Side View )

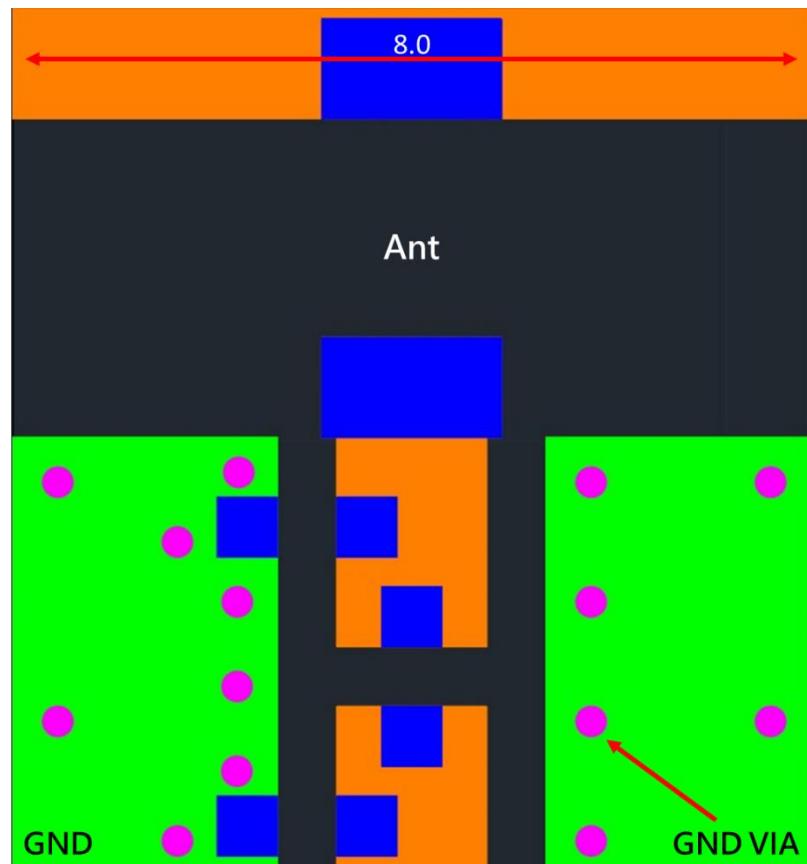
( Bottom View )

Symbols	L	W	T	A
Dimensions	3.2+/-0.2	1.6+/-0.2	0.5+/-0.1	0.4+/-0.1

**2). PCB Top View (Unit : mm) :**



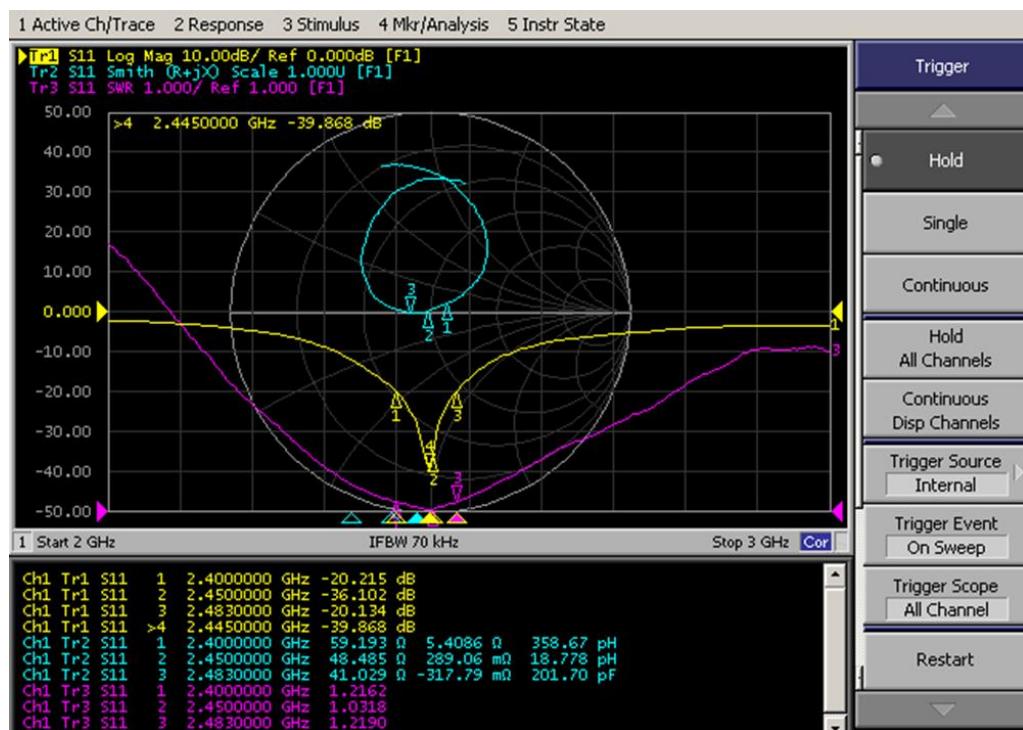
### 3). Suggest PCB Layout (Unit : mm) :



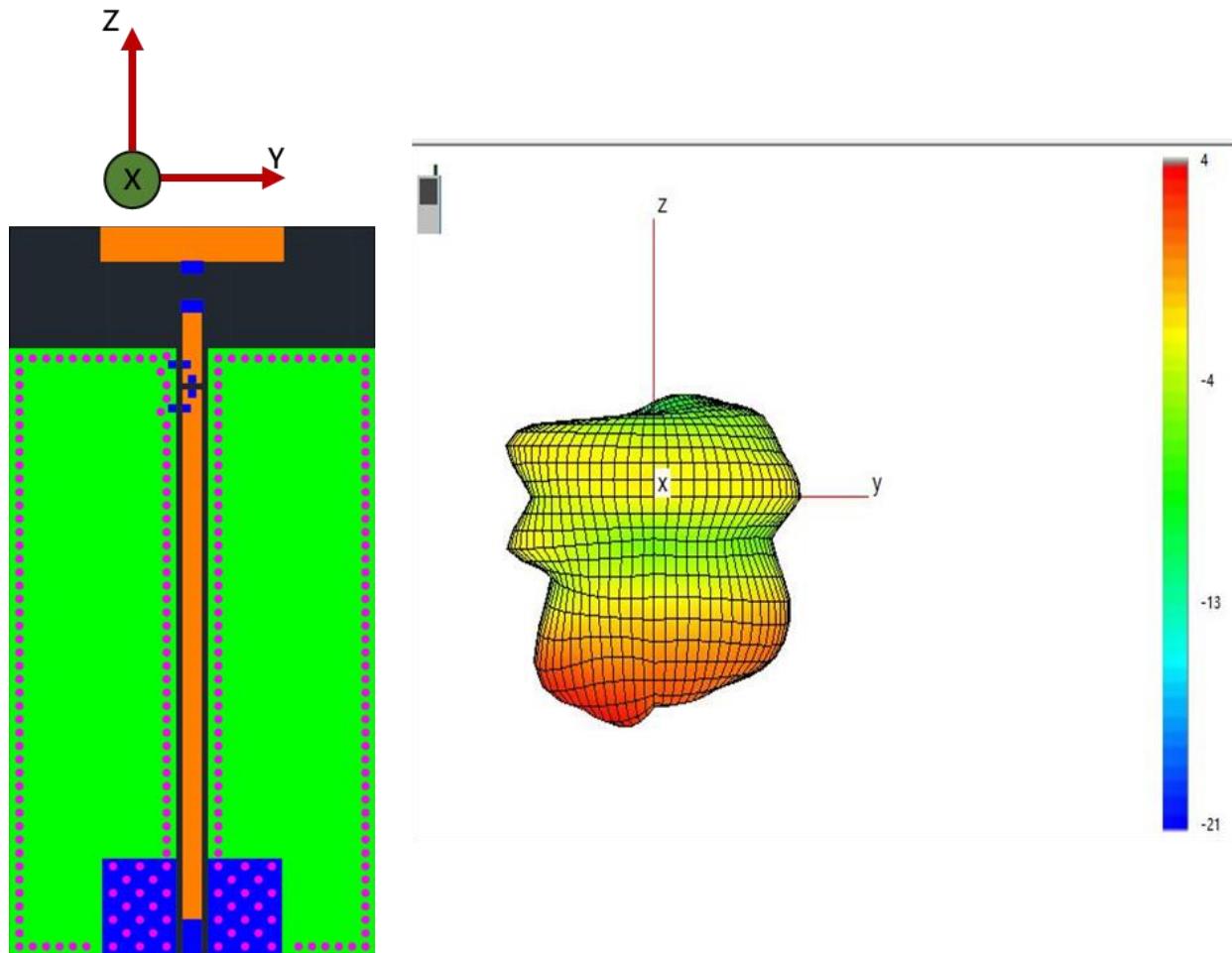
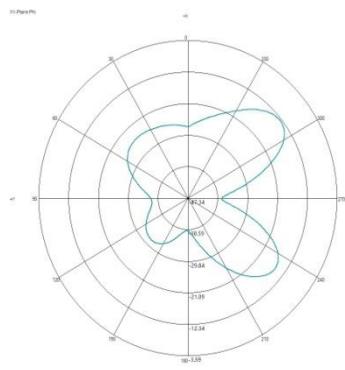
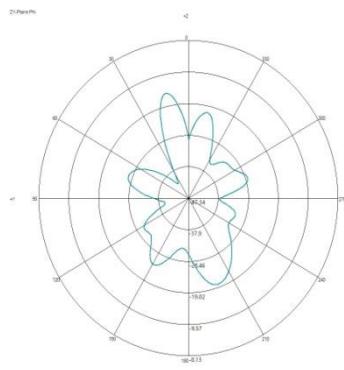
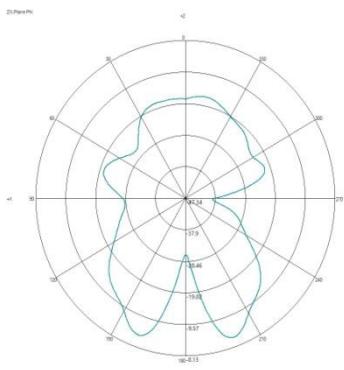
#### 4. Electrical Characteristics

Specification		
Part Number	W1	
Central Frequency	2450	MHz
Bandwidth	100 (Min.)	MHz
Return Loss	-10 (Max)	dB
Peak Gain	3.64	dBi
Impedance	50	$\Omega$
Operating Temperature	-40~+85	°C
Maximum Power	1	W
Resistance to Soldering Heats	10 ( @ 260°C)	sec.
Polarization	Linear	
Azimuth Beamwidth	Omni-directional	
Termination	Cu / Sn (Leadless)	

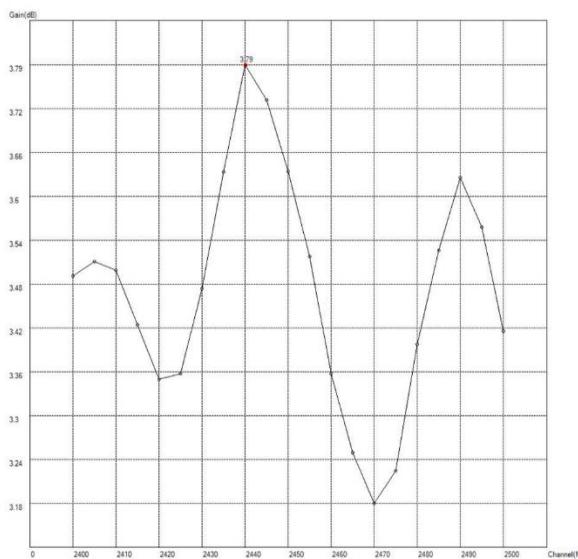
#### 5. Return Loss



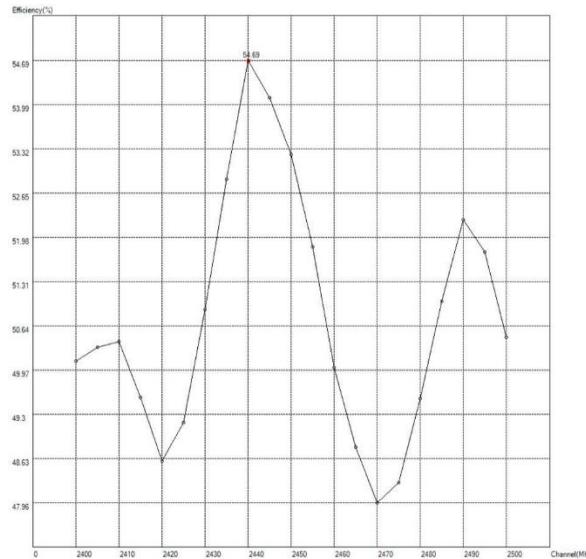
## 6. Radiation Pattern & Efficiency

**XY-Plane Total****ZY-Plane Total****ZX-Plane Total**

Gain-Plane

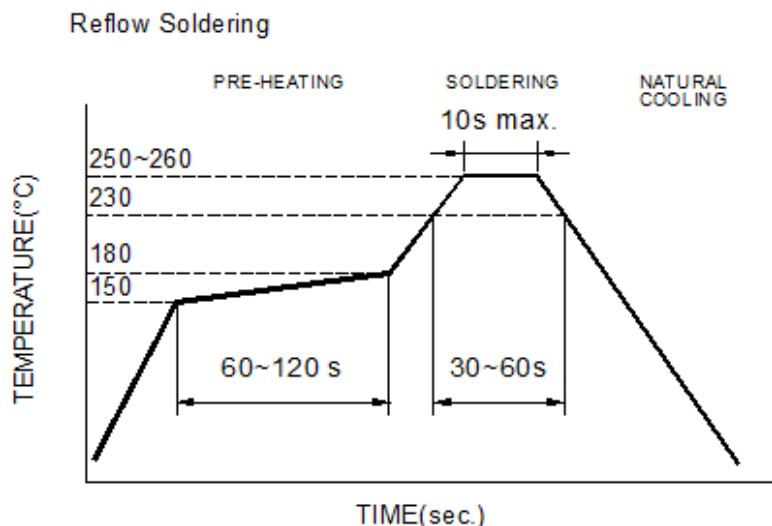


Efficiency-Plane



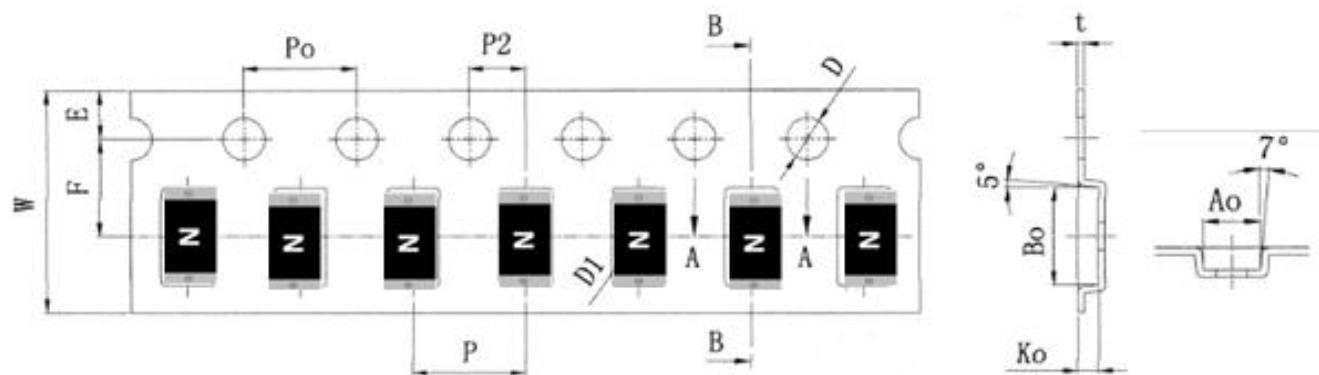
Frequency (MHz)	2400	2450	2500
Efficiency (dB)	-3.00	-2.73	-2.96
Efficiency (%)	50.11	53.26	50.47
Gain (dBi)	3.49	3.64	3.42

## 7. Reflow Soldering Standard Condition



## 8. Packaging and Dimensions 3.2\*1.6mm

### ◆ Plastic Tape

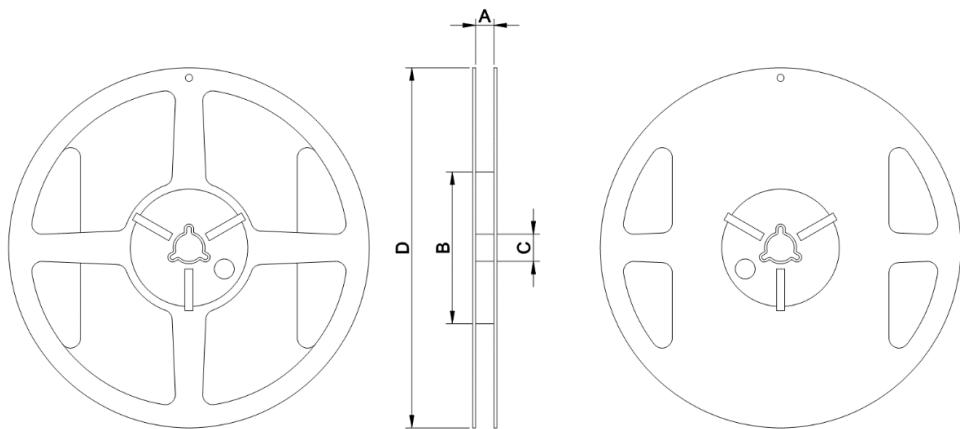


外觀	規格	公差
W	8.00	$\pm 0.10$
P	4.00	$\pm 0.10$
E	1.75	$\pm 0.10$
F	3.50	$\pm 0.05$
P2	2.00	$\pm 0.05$
D	1.50	$^{+0.10}_{-0.00}$
D1	1.00	$\pm 0.10$
Po	4.00	$\pm 0.10$
10Po	40.00	$\pm 0.20$

外觀	規格	公差
Ao	1.85	$\pm 0.10$
Bo	3.50	$\pm 0.10$
Ko	0.73	$\pm 0.10$
t	0.23	$\pm 0.05$

**◆ Remarks for Package**

Reserve a length of 150~200mm for the trailer of the carrier and 250~300 mm for the leader of the carrier and further 250mm of cover tape at the leading part of the carrier.

**◆ Reel (5000 pcs/Reel)**

Tape Width(mm)	A(mm)	B(mm)	C(mm)	D(mm)	Chip/Reel(pcs)
8	9.0±0.5	60±2	13.5±0.5	178±2	3000

**◆ Storage Period**

Oxidizable Material, 12 months in vacuum sealed bag, please repack within 168 hours by re-seal the package treatment after using.

Storage Temperature Range : <30 degree C, Humidity : <60%RH

## 9. Dependability Test

Test item	Test condition / Test method	Specification
Solderability IEC 60068-2-58 GB/T2423.28	*Solder bath temperature: 240±5°C *Immersion time: 2±0.5 sec Solder: Sn96.5Ag3.0Gu0.5 for lead-free.	At least 95% of a surface of each terminal electrode must be covered by fresh solder.
Leaching (Resistance to dissolution of metallization) JIS C5101	*Solder bath temperature: 260±5°C *Leaching immersion time: 10±1 sec Solder : Sn96.5 Ag3.0 Gu0.5 for lead-free.	Loss of metallization on the edges of each electrode shall not exceed 25%.
Resistance to soldering heat IEC 60068-2-58 GB/T2423.28	*Preheating temperature: 120~150°C , 1 minute. *Solder temperature: 260±5°C *Immersion time: 10±1 sec Solder: Sn96.5Ag3.0Gu0.5 for lead-free Measurement to be made after keeping at room temperature for 24±2 hrs.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature. Loss of metallization on the edges of each electrode shall not exceed 25%.
Drop Test IEC 60068-2-32 GB/T2423.8 Customer's specification.	*Height : 50 cm *Test Surface: Rigid surface of concrete or steel. *Times : 6 surfaces for each units ; 2 times for each side.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
Vibration IEC 60068-2-6 GB/T 2423.10	*Frequency : 10Hz~55Hz~10Hz(1min) *Total amplitude : 1.5mm *Test times: 6hrs.(Two hrs each in three mutually perpendicular directions)	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
Adhesive Strength of Termination IEC60068-2-21 GB/T 2423.6	*Pressurizing force : 5N( $\leq$ 0603) ; 10N(>0603) *Test time:10±1 sec	No remarkable damage or removal of the termination.

Bending test IEC 60068-2-21 GB/T 2423.29	The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1 mm/s per second until the deflection becomes 2mm and then pressure shall be maintained for 10±1 sec. Measurement to be made after keeping at room temperature for 24±2 hours.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
Temperature cycle IEC60068-2-14 GB/T 2423.22	30 minutes at -40°C±2°C. 10~15 minutes at room temperature. 30minutes at +85°C±2°C. 10~15 minutes at room temperature. Total 100 continuous cycles Measurement to be made after keeping at room temperature for 24±2 hrs.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
High temperature IEC 60068-2-2 GB/T2423.2	*Temperature: 85±2°C. *Test duration: 500+24/-0 hours. Measurement to be made after keeping at room temperature for 24±2 hrs.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics.
Humidity (steady conditions) IEC60068-2-3 GB/T 2423.3	*Humidity : 85±5%R.H. *Temperature: 85±2°C. *Time : 500+24/-0 hrs. Measurement to be made after keeping at room temperature for 24±2 hrs ※ 200hrs measuring the first data then 300hrs data.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
Low temperature IEC 60068-2-1 GB/T2423.1	*Temperature: -40±2°C. *Test duration: 500+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hrs.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.